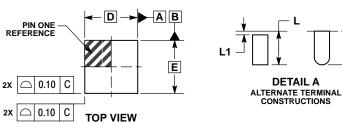
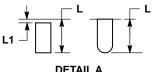
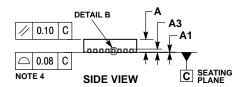


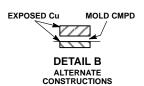
QFN28 3.5x3.5, 0.4P CASE 485DW ISSUE O

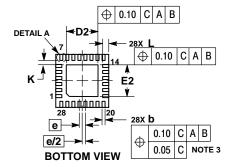
DATE 08 AUG 2014



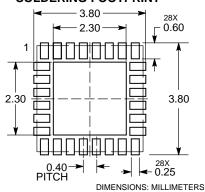








RECOMMENDED SOLDERING FOOTPRINT*



^{*}For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

NOTES:

- NOTES.

 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.

 2. CONTROLLING DIMENSION: MILLIMETERS.

 3. DIMENSION b APPLIES TO PLATED
- TERMINAL AND IS MEASURED BETWEEN 0.15 AND 0.30 MM FROM TERMINAL.
- COPLANARITY APPLIES TO THE EXPOSED PAD AS WELL AS THE TERMINALS.

	MILLIMETERS	
DIM	MIN	MAX
Α	0.80	1.00
A1	0.00	0.05
A3	0.20 REF	
b	0.15	0.25
D	3.50 BSC	
D2	2.00	2.20
Е	3.50 BSC	
E2	2.00	2.20
е	0.40 BSC	
K	0.30 REF	
L	0.30	0.50
L1		0.15

GENERIC MARKING DIAGRAM*



XXXXX = Specific Device Code

= Assembly Location Α

L = Wafer Lot

Υ = Year W = Work Week

= Pb-Free Package

(Note: Microdot may be in either location)

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " ■", may or may not be present.

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STATUS:	ON SEMICONDUCTOR STANDARD
NEW STANDARD:	
DESCRIPTION:	QFN28 3.5X3.5, 0.4P

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DOCUMENT	NUMBER:
98AON89418	3F

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SSUE	REVISION	DATE
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